

## Ultra Small Low Profile 0603 Balun $50\Omega$ to $75\Omega$ Balanced

## **Description**

The BD4859L5075A00 is an ultra-small low profile balanced to unbalanced transformer designed for differential inputs and output locations on next generation wireless chipsets in an easy to use surface mount package covering 802.11a Uni-Band II and Uni-Band III and the Japanese ISM band (4.9GHz). The BD4859L5075A00 is ideal for high volume manufacturing and is higher performance than traditional ceramic baluns. The BD4859L5075A00 has an unbalanced port impedance of  $50\Omega$  and a  $75\Omega$  balanced port impedance. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The BD4859L5075A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

## Features:

- 4800 5900 MHz
- 0.7mm Height Profile
- 50 Ohm to 2 x 37 Ohm
- Covers 802.11a Uni-Band II & III
- Low Insertion Loss
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant

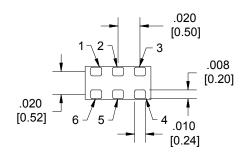
	R	ROOM (25°C)			
Parameter	Min.	Тур.	Max	Unit	
Frequency	4800		5900	MHz	
Unbalanced Port Impedance		50		Ω	
Balanced Port Impedance		75		Ω	
Return Loss	9	13		dB	
Insertion Loss*		0.9	1.3	dB	
Amplitude Balance		0.5	1.3	dB	
Phase Balance		2	6.0	Degrees	
CMRR		31		dB	
Power Handling			2	Watts	
Operating Temperature	-55		+85	℃	

<sup>\*</sup> Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

### **Outline Drawing**

Top View (Near-side) Side View .027±.002 [0.70±0.05] .059±.004 [1.50±0.10] .029±.004 [0.75±0.10] Orientation Marker Denotes Pin Location Pin Designation **Unbalanced Port** DC Bias/GND **Balanced Port Balanced Port** Dimensions are in Inches [Millimeters] GND Mechanical Outline GND

Bottom View (Far-side)



Tolerances are Non-Cumulative



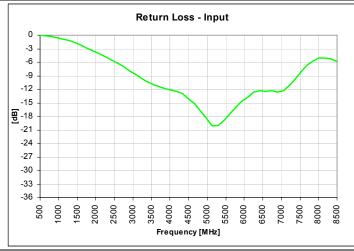


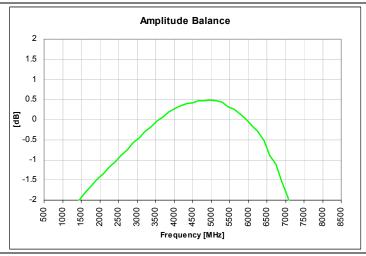
Available on Tape and Reel for Pick and Place Manufacturing.

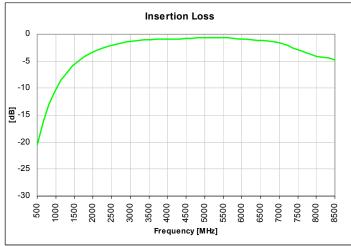
USA/Canada: (315) 432-8909 Toll Free: (800) 411-6596 Europe: +44 2392-232392

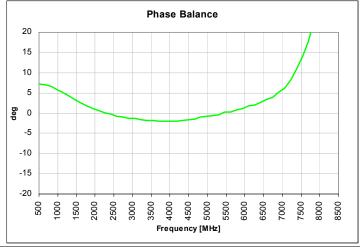


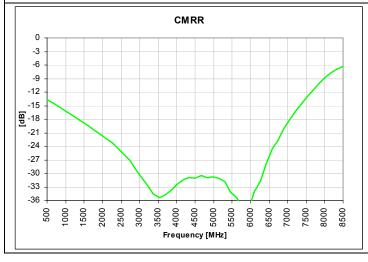
## Typical Broadband Performance: 500 MHz. to 8000 MHz.











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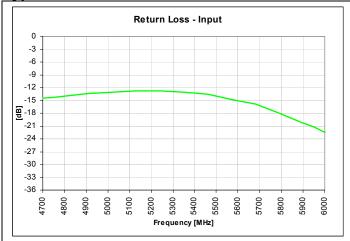
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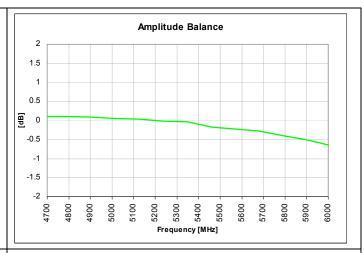




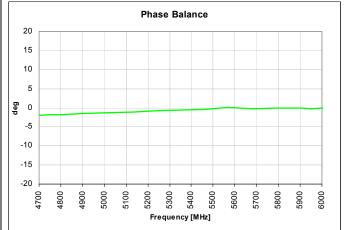


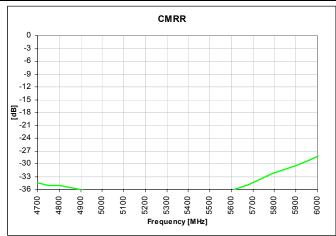
## Typical Performance: 4700 MHz. to 6000 MHz.

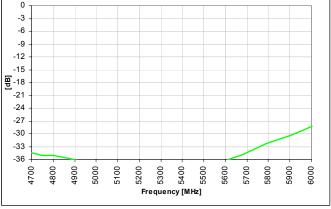














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## Model BD4859L5075A00

Rev C



## **Mounting Configuration:**

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

An example of the PCB footprint used in the testing of these parts is shown below. An example of a DC-biased footprint is also shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

#### **No Bias Footprint DC Bias Footprint** 6X .013 2X .006 Part Orientation (Top View) Part Orientation (Top View) 6X .011 6X .002 [0.05] Plated thru holes to ground 3X Transmission Plated thru holes to Line Circuit Pattern Circuit Pattern Footprint Pad (s) Footprint Pad (s) Dimensions are in Inches [Millimeters] 0603 Standaard Mounting Footprint Solder Resist \\\\\ Solder Resist

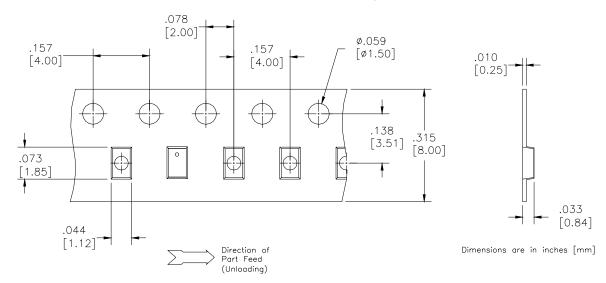
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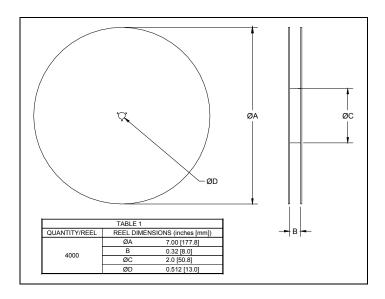




## **Packaging and Ordering Information**

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.











# BD 2425 J 50 100 A 00

Function	Frequency	Package	Unbalan	ced Balanc	ed Impedance	Plating	Codes		
		Dimensions	Impedar	nce +	Coupling	Finish	Codes		
B = Balun BD = Balun - F = Filter FB = Filter / C = 3dB Cou DC = Direction J = RF Jump X = RF cross	+ DC Balun pler onal er	0110 = 100 - 1000 MHz 0810 = 800 - 1000 MHz 0922 = 950 - 2150 MHz 0826 = 800 - 6200 MHz 1222 = 1200 - 2200 MHz 1416 = 1400 - 1600 MHz 1722 = 1700 - 2200 MHz 2326 = 2300 - 2600 MHz 2425 = 2400 - 2500 MHz 3150 = 3100 - 5000 MHz 3436 = 3400 - 3600 MHz 4859 = 4800 - 3600 MHz	Dimensions  A = 150 x 150 mils (4mm × 4mm)  C = 120 x 120 mils (3mm × 3mm)  E = 100 x 80 mils (25mm × 2mm)  J = 80 x 50 mils (2mm × 125mm)  L = 60 x 30 mils (15mm × 0.75mm)  N = 40 x 40 mils (1mm × 1mm)	150 = 50 Ohm 75 = 75 Ohm	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Balanced Balanced Balanced Balanced Balanced Ω Balanced Ω Balanced Ω Balanced Ω Balanced Ω Balanced	FINISH A = Gold P = Tin-Lead		
		5153 = 5100 - 5300 MHz 5159 = 5100 - 5900 MHz 5759 = 5700 - 5900 MHz							

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Available on Tape and Reel for Pick and Place Manufacturing.

